

UNISONIC TECHNOLOGIES CO., LTD

7NM80D-Q Preliminary Power MOSFET

7.0A, 800V N-CHANNEL SUPER-JUNCTION MOSFET

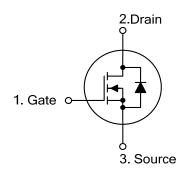
DESCRIPTION

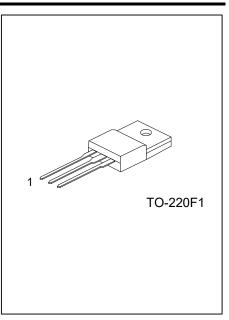
The **UTC 7NM80D-Q** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)} \le 0.95 \Omega$ @ V_{GS} =10V, I_D =3.5A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

■ SYMBOL





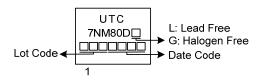
ORDERING INFORMATION

Ordering Number		Daakana	Pin Assignment			Deakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
7NM80DL-TF1-T	7NM80DG-TF1-T	TO-220F1	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source

7NM80DG-TF1-T
(1)Packing Type
(1) T: Tube
(2)Package Type
(3)Green Package
(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	800	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	ΙD	7	Α
	Pulsed (Note 2)	I _{DM}	14	Α
Avalanche Energy	Single Pulsed (Note 3)	Eas	225	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6.5	V/ns
Power Dissipation		P _D	27	W
Junction Temperature		TJ	+150	°C
Storage Temperature Range		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 100mH, I_{AS} = 2.1A, V_{DD} = 50V, R_{G} = 25 Ω Starting T_{J} = 25°C.
- 4. I_{SD} \leq 7.0A, di/dt \leq 200A/ μ s, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C.

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	4.63	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

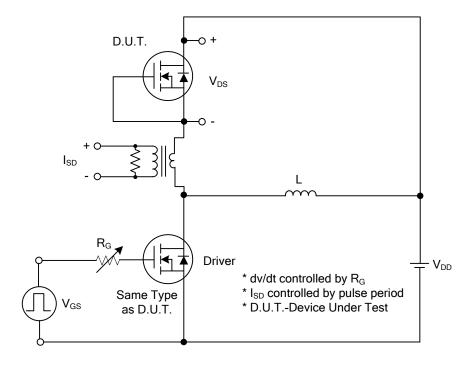
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	800			V		
Drain-Source Leakage Current	I _{DSS}	V _{DS} =800V, V _{GS} =0V			10	μΑ		
Gate-Source Leakage Current	Igss	$V_{DS}=0V$, $V_{GS}=\pm30V$			±10	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	2.5		4.5	V		
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3.5A			0.95	Ω		
DYNAMIC PARAMETERS								
Input Capacitance	Ciss			556		pF		
Output Capacitance	Coss	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		80		pF		
Reverse Transfer Capacitance	Crss			4		pF		
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)	Q_{G}	V _{DS} =640V, V _{GS} =10V, I _D =7.0A , (Note 1, 2)		28		nC		
Gate to Source Charge	Q _G s			7		nC		
Gate to Drain Charge	Q_{GD}			12.6		nC		
Turn-ON Delay Time (Note 1)	t _{D(ON)}			8		ns		
Rise Time	t _R	V _{DD} =100V, V _{GS} =10V,		20		ns		
Turn-OFF Delay Time	t _{D(OFF)}	I _D =7.0A, R _G =25Ω (Note 1, 2)		64		ns		
Fall-Time	t⊦			36		ns		
SOURCE- DRAIN DIODE RATINGS AND CHA	ARACTERIS [*]	TICS						
Maximum Body-Diode Continuous Current	ls				7	Α		
Maximum Body-Diode Pulsed Current	Іѕм				14	Α		
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =7.0A, V _{GS} =0V			1.4	V		
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =7.0A, V _{GS} =0V,		348		ns		
Body Diode Reverse Recovery Charge	Qrr	dI _F /dt=100A/µs		3.97		μC		

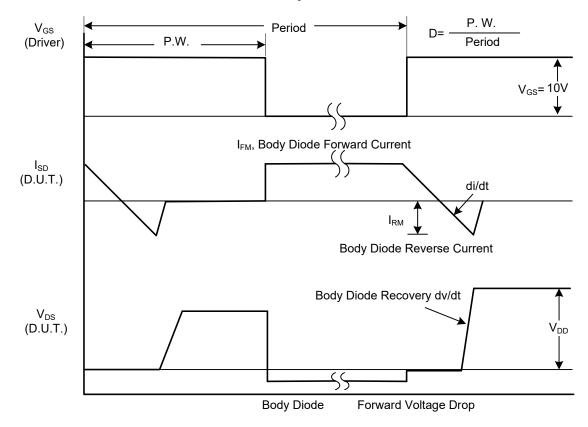
Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

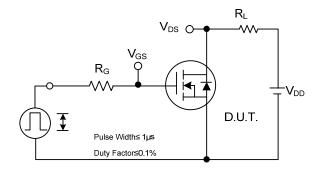


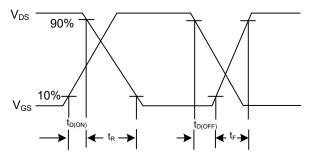
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

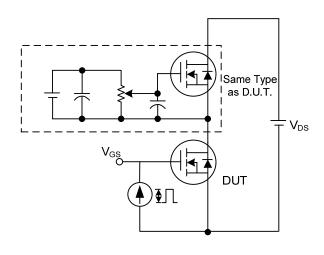
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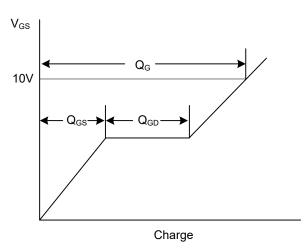




Switching Test Circuit

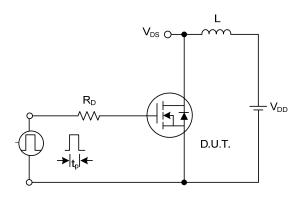
Switching Waveforms

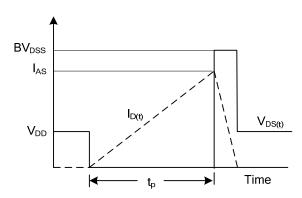




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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